

PATENT ASSIGNMENT COVER SHEET

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| YEONOK KIM | 08/16/2018 |
| GEUN HUH | 08/16/2018 |
| JU-YOUNG JUNG | 08/16/2018 |
| JUNG-HWA LEE | 08/16/2018 |
| JONG HAN YANG | 08/16/2018 |
| RECEIVING PARTY DATA | |
| Name: | ROHM AND HAAS ELECTRONIC MATERIALS KOREA LTD |
| Street Address: | 56, 3-GONDAN 1-RO |
| Internal Address: | SEOBUK-GU, CHEONAN-SI, CHUNGCHONGNAM-DO |
| City: | CHEONAN |
| State/Country: | KOREA, REPUBLIC OF |
| Postal Code: | 31093 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 16192013 |
| CORRESPONDENCE DATA | |
| Fax Number: | (302)355-4243 |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | |
| Phone: | 3029994278 |
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| Correspondent Name: | DUPONT DE NEMOURS INC |
| Address Line 1: | 974 CENTRE ROAD |
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| Address Line 4: | WILMINGTON, DELAWARE 19805 |
| ATTORNEY DOCKET NUMBER: | DI81173USNP |
| NAME OF SUBMITTER: | JULIE HANSON |
| SIGNATURE: | /Julie Hanson/ |
| DATE SIGNED: | 09/29/2021 |

Total Attachments: 1

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[illegible]

This Assignment 110 is in the ENGLISH language and has the same meaning in other languages with the same 110 number and R/Date

FORM 110 (R 5/97)

INDIVIDUAL ASSIGNMENT AND INVENTOR'S DECLARATION (with Priority Rights)

I/we verily believe I am/we are the original, first and sole/joint inventor(s) of the subject matter which is embraced by and for which a patent is sought on the invention entitled: **POSITIVE-TYPE PHOTSENSITIVE RESIN COMPOSITION AND HARDENED OVERCOAT LAYER PREPARED THEREFROM**

which invention was made and invented by me/us out of and in the course of my/our employment with my/our respective employers as stated below my/our name(s). I/we acknowledge that I/we hold the invention and all patent and other rights and powers obtainable or exercisable in respect thereof in trust for our respective employers. As trustee(s), and for good and valuable consideration and/or the remuneration received for my/our work, I/we sell, assign and transfer unto:

Rohm and Haas Electronic Materials Korea Ltd.
56, 3-Gondan 1-ro, Seobuk-gu, Cheonan-si
Chungcheongnam-do
Republic of Korea 31093

an entity organized and existing under the laws of **Korea, Republic of** (hereinafter referred to as the "Assignee"); my/our entire right, title and interest throughout the world, in and to the invention and all rights and powers to make applications, including provisional applications when permitted by law, for Letters Patent in its own name, or in the name of its designee (or nominee(s)); and all rights and powers to file any corresponding or equivalent applications in any and all countries, including all rights to claim priority under all United States domestic laws, International Convention(s) and Treaties in the name of Assignee, and do hereby authorize Assignee or its designee to insert here the Priority Number, Filing Date, and Filing Country

| | | |
|-----------------|------------------|----------------|
| Priority Number | Filing Date | Filing Country |
| 10-2017-0183384 | 29 December 2017 | South Korea |
| | | |


of the application, on which the claim for priority will be based; and in and to any Letters Patent that may be issued for the invention in any and all countries. I/we do hereby agree to assist Assignee in the prosecution of the application(s) and in any interference, conflict, opposition or litigation which may arise involving the invention or the patent or patents thereon, and to execute for any and all countries any document relating to applications derived from, corresponding to or equivalent to the above identified application as Assignee may request.

I/we authorize Assignee or its designee to translate this Assignment into all languages necessary; and we request that any such Letters Patent be issued to Assignee; and consent to the recordal of this Assignment, or a Notarial True Copy thereof, being under covenant not only that I/we have full power to make the same, but also that such assigned rights are not encumbered by any grant, license, or other right heretofore given.


Subscribed and Declared by me/us:

At: Gyeonggi-do, South Korea
 this 16 day of 9, 20 19
 Effective as of: 29 December 2017
 Signature: [Signature]
 Full Name: KIM, Yeonok
 Mailing Address: 20, Samsung 1-Ro 5-Gil, Hwaseong-si,
 Gyeonggi-Do
 Republic of Korea 18449

At: Gyeonggi-do, South Korea
 this 16 day of 08, 20 10
 Effective as of: 29 December 2017
 Signature: [Signature]
 Full Name: HUH, Geun
 Mailing Address: 20, Samsung 1-Ro 5-Gil, Hwaseong-si,
 Gyeonggi-Do
 Republic of Korea 18449

At: Gyeonggi-do, South Korea
 this 16 day of 8, 20 18
 Effective as of: 29 December 2017
 Signature: 
 Full Name: JUNG, Ju-Young
 Mailing Address: 20, Samsung 1-Ro 5-Gil, Hwasong-si,
 Gyeonggi-Do
 Republic of Korea 18449

At: Gyeonggi-do, South Korea
 this 16 day of 8, 20 18
 Effective as of: 29 December 2017
 Signature: jh
 Full Name: LEE, Jung-Hwa
 Mailing Address: 20, Samsung 1-Ro 5-Gil, Hwaseong-si,
 Gyeonggi-Do
 Republic of Korea 18449

At: Gyeonggi-do, South Korea
 this 16 day of 8, 20 18
 Effective as of: 29 December 2017
 Signature: 
 Full Name: YANG, Jong Han
 Mailing Address: 20, Samsung 1-Ro 5-Gil, Hwasong-si,
 Gyeonggi-Do
 Republic of Korea 18449

At: _____
 this _____ day of _____, 20____
 Effective as of: _____
 Signature: _____
 Full Name: _____
 Mailing Address: _____

At: _____
this _____ day of _____, 20____
Effective as of: _____

Signature: _____
Full Name: _____
Mailing Address: _____

At: _____
 this _____ day of _____, 20 _____
 Effective as of: _____
 Signature: _____
 Full Name: _____
 Mailing Address: _____

PATENT